

General Description

The CMSA8059A uses advanced trench technology to provide excellent RDS(ON).

This device is a suitable device for a DC to DC converter and general-purpose applications.

Features

- Low On-Resistance
- 100% avalanche tested
- Small Footprint (5x6 mm) for Compact Design
- RoHS Compliant

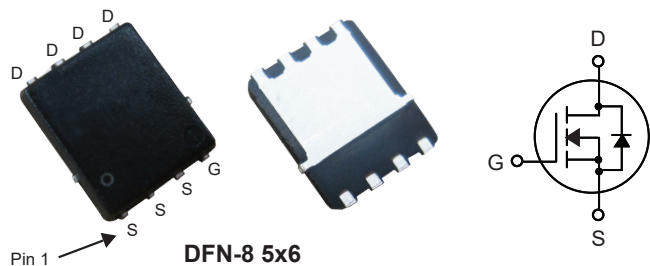
Product Summary

BVDSS	RDS(on) max.	ID
30V	3mΩ	100A

Applications

- DC-DC Converters

DFN-8 5x6 Pin Configuration



Type	Package	Marking
CMSA8059A	DFN-8 5x6	CMSA8059A

Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	30	V
V _{GS}	Gate-Source Voltage	±20	V
I _D @T _C =25°C	Continuous Drain Current	100	A
I _D @T _C =100°C	Continuous Drain Current	65	A
I _{DM}	Pulsed Drain Current	400	A
EAS	Single Pulse Avalanche Energy ¹	289	mJ
P _D @T _C =25°C	Total Power Dissipation	100	W
T _{STG}	Storage Temperature Range	-55 to 150	°C
T _J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
R _{θJA}	Thermal Resistance Junction-ambient(min. footprint)	---	105	°C/W
R _{θJC}	Thermal Resistance Junction-case	---	1.25	°C/W

Electrical Characteristics($T_J=25^{\circ}\text{C}$, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V$, $I_D=250\mu A$	30	---	---	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS}=10V$, $I_D=28A$	---	2.5	3	mΩ
		$V_{GS}=4.5V$, $I_D=15A$	---	4.2	5	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_D=250\mu A$	1.0	---	2.5	V
I_{DSS}	Drain-Source Leakage Current	$V_{DS}=30V$, $V_{GS}=0V$	---	---	1	μA
I_{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm 20V$, $V_{DS}=0V$	---	---	± 100	nA
g_{fs}	Forward Transconductance	$V_{DS}=5V$, $I_D=15A$	---	31	---	S
R_g	Gate Resistance	$V_{DS}=0V$, $V_{GS}=0V$, $f=1\text{MHz}$	---	1.3	---	Ω
Q_g	Total Gate Charge	$I_D=40A$	---	50	---	nC
Q_{gs}	Gate-Source Charge	$V_{DS}=15V$	---	9.5	---	
Q_{gd}	Gate-Drain Charge	$V_{GS}=10V$	---	13.5	---	
$T_{d(on)}$	Turn-On Delay Time	$V_{DS}=15V$ $V_{GS}=10V$, $R_{G_{ext}}=2.7\Omega$ $I_D=40A$	---	12	---	ns
T_r	Rise Time		---	104	---	
$T_{d(off)}$	Turn-Off Delay Time		---	35	---	
T_f	Fall Time		---	109	---	
C_{iss}	Input Capacitance	$V_{DS}=25V$, $V_{GS}=0V$, $f=1\text{MHz}$	---	2600	---	pF
C_{oss}	Output Capacitance		---	350	---	
C_{rss}	Reverse Transfer Capacitance		---	270	---	

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_S	Continuous Source Current	$V_G=V_D=0V$, Force Current	---	---	100	A
I_{SM}	Pulsed Source Current		---	---	400	A
V_{SD}	Diode Forward Voltage	$V_{GS}=0V$, $I_S=20A$, $T_J=25^{\circ}\text{C}$	---	0.79	1.3	V
t_{rr}	Reverse Recovery Time	$di/dt = 100A/\mu s$	---	18	---	ns
Q_{rr}	Reverse Recovery Charge	$T_J = 25^{\circ}\text{C}$, $I_F = 40A$	---	8	---	nC

Note :

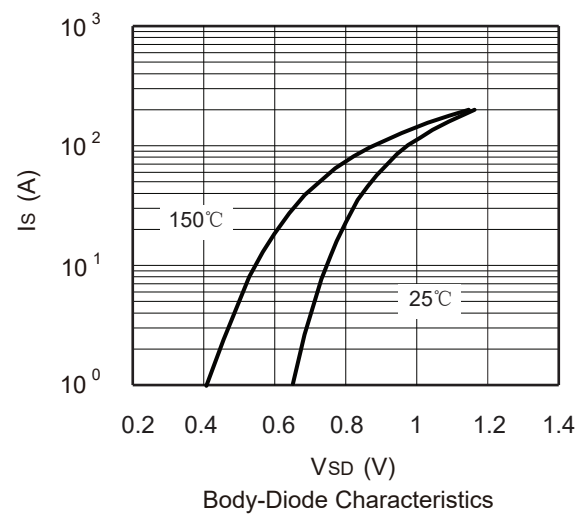
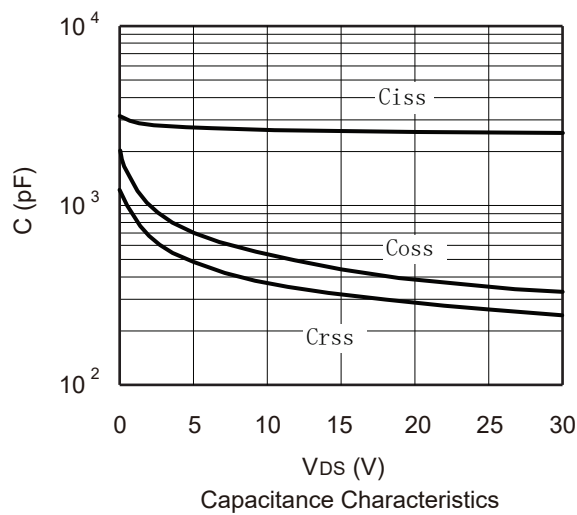
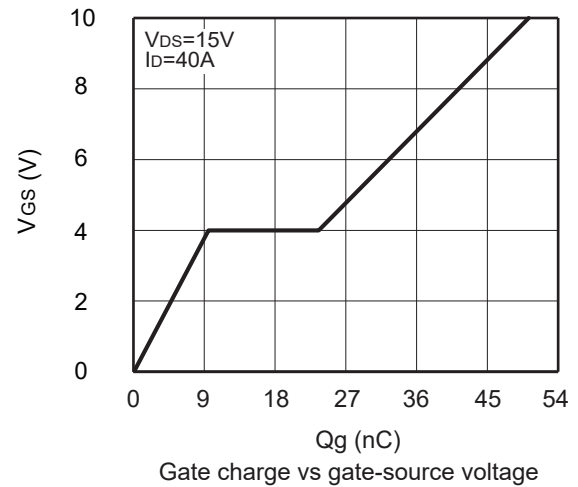
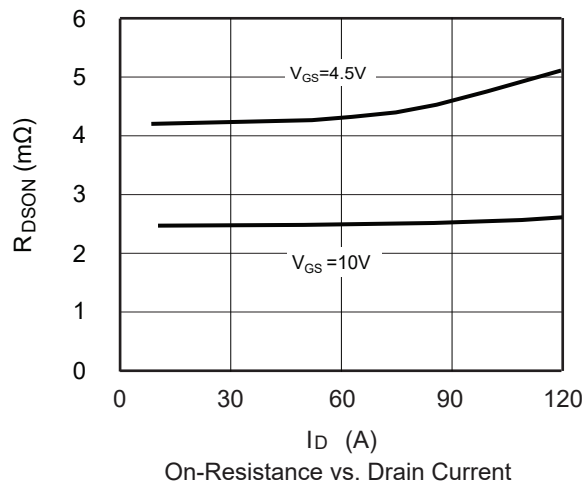
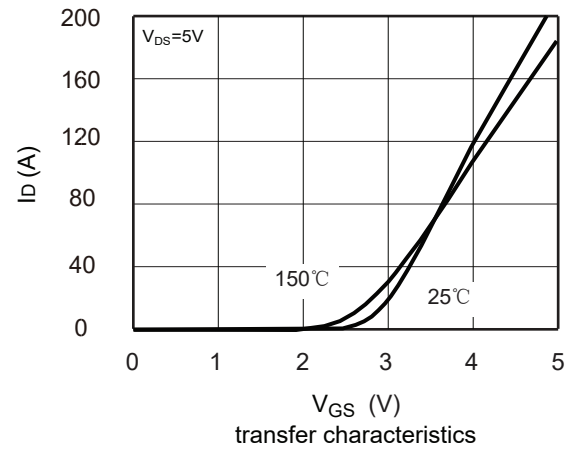
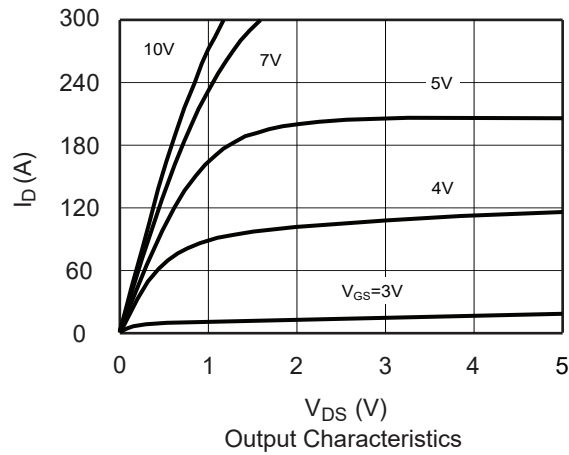
1.The EAS data shows Max. rating . The test condition is $V_{DD}=28V$, $V_{GS}=10V$, $L=0.5\text{mH}$, $I_{AS}=34A$.

This product has been designed and qualified for the consumer market.

Cmos assumes no liability for customers' product design or applications.

Cmos reserves the right to improve product design, functions and reliability without notice. Please refer to the latest version of specification.

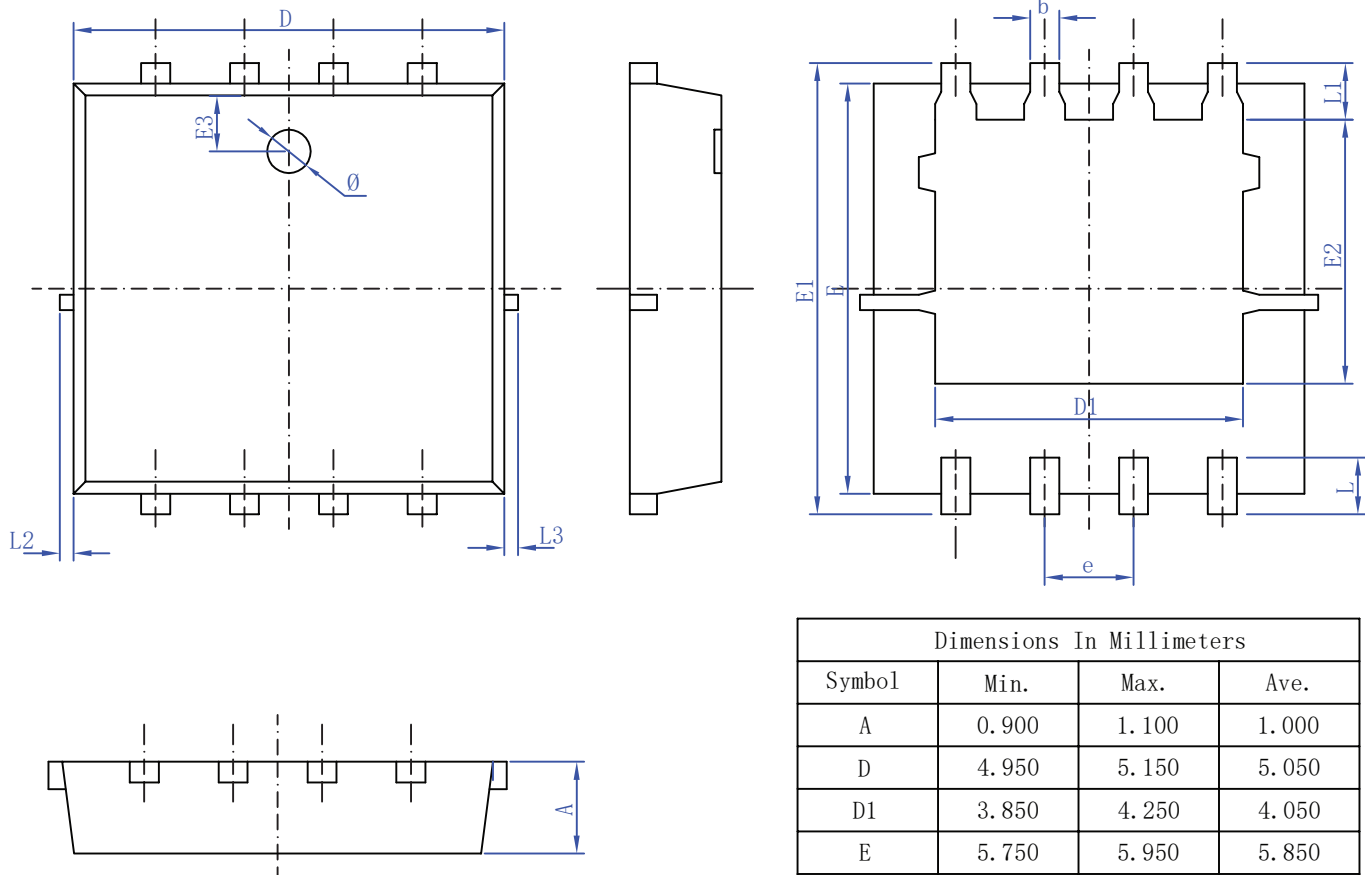
Typical Characteristics



Package Dimension

DFN-8 5x6

Unit :mm



注:

1. 未注公差 ± 0.05 未标注圆角 $R_{\max}=0.25$

Dimensions In Millimeters			
Symbol	Min.	Max.	Ave.
A	0.900	1.100	1.000
D	4.950	5.150	5.050
D1	3.850	4.250	4.050
E	5.750	5.950	5.850
E1	5.950	6.350	6.150
E2	3.300	3.700	3.500
E3	0.900	1.300	1.100
b	0.250	0.350	0.300
e	1.220	1.320	1.270
L	0.585	0.785	0.685
L1	0.525	0.725	0.625
Ø	1.000	1.400	1.200
L2	0~0.100		
L3	0~0.100		